### 3.2x2.4mm SMD CHIP LED LAMP



**ATTENTION** OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE

**DEVICES** 

P/N: KPD-3224PBC

BLUE

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#### **Features**

- •3.2x2.4mm SMT LED, 2.4mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- ●PACKAGE: 1500PCS / REEL.
- ●RoHS COMPLIANT.

#### **Description**

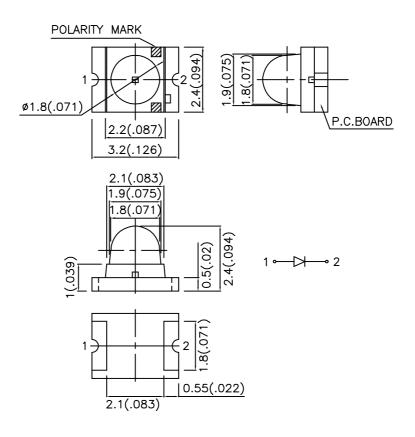
The Blue source color devices are made with InGaN on SiC Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

### **Package Dimensions**



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.

  3. Specifications are subject to change without notice.

SPEC NO: DSAB2512 **REV NO: V.8** DATE: NOV/12/2005 APPROVED: J. Lu **CHECKED: Allen Liu** DRAWN: W.J.ZHU

## Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 20mA		Viewing Angle
		,	Min.	Тур.	2 <del>0</del> 1/2
KPD-3224PBC	BLUE (InGaN)	WATER CLEAR	110	380	20°

Note

## Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue	468		nm	IF=20mA
λD	Dominant Wavelength	Blue	470		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue	25		nm	IF=20mA
С	Capacitance	Blue	65		pF	VF=0V;f=1MHz
VF	Forward Voltage	Blue	3.65	4.2	V	IF=20mA
IR	Reverse Current	Blue		10	uA	VR = 5V

## Absolute Maximum Ratings at Ta=25°C

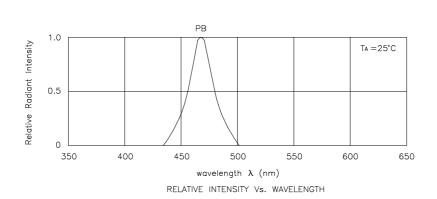
Parameter	Blue	Units	
Power dissipation	102	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	160	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		

Note

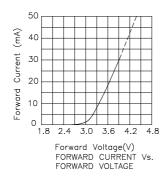
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

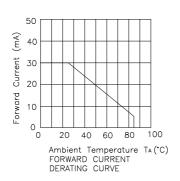
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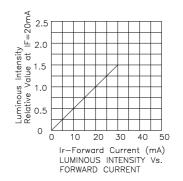
 $<sup>1. \, \</sup>theta 1/2$  is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

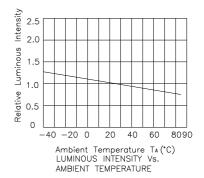


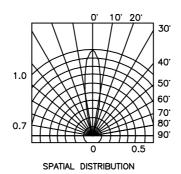
### Blue KPD-3224PBC







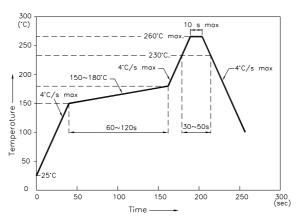




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### KPD-3224PBC

Reflow Soldering Profile For Lead-free SMT Process.

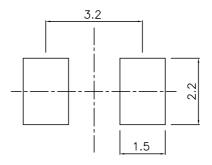


- NOTES:

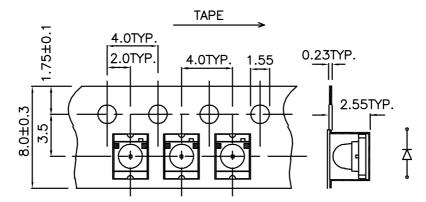
  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
  - 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
  - 3. Number of reflow process shall be 2 times or less.

## **Recommended Soldering Pattern**

(Units: mm)



## **Tape Specifications** (Units: mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity/ luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity/ Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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